

Appl. No. 09/754,264
Amendment/Response in reply
to the Notice of Non-
Compliant Amendment dated
April 27, 2004

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IN THE UNITED STATES
PATENT AND TRADEMARK OFFICE

Appl. No.: 09/754,264

Applicant(s): Tetsuo Usami, et al.

Filed: January 5, 2001

Title: Deposition Method For Wiring Thin Film

TC/A.U.: 2800/2814

Examiner: S. H. Rao

Atty. Docket: OKI.202

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On: 14 May 2004

By: Michelle Welgus
Michelle Welgus

AMENDMENT and/or RESPONSE UNDER 37 C.F.R. § 1.111

Honorable Assistant Commissioner of Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Notice of Non-Compliant Amendment dated April 27, 2004,
kindly reconsider the application in view of the following amendments and remarks.

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1. **Amendments to the claims** reflected in the complete listing of the claims,
which begins on page 3 of this paper; and
2. **Remarks/Discussion of issues**, which begin on page 7 of this paper.